

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Vineet MITTAL</td> <td>08/09/2012</td> </tr> <tr> <td>Kalle Ilmari AHMAVAARA</td> <td>08/09/2012</td> </tr> <tr> <td>Prabhu GOVINDASWAMY</td> <td>08/09/2012</td> </tr> </tbody> </table>		Name	Execution Date	Vineet MITTAL	08/09/2012	Kalle Ilmari AHMAVAARA	08/09/2012	Prabhu GOVINDASWAMY	08/09/2012		
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Vineet MITTAL	08/09/2012										
Kalle Ilmari AHMAVAARA	08/09/2012										
Prabhu GOVINDASWAMY	08/09/2012										
RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>Qualcomm Incorporated</td> </tr> <tr> <td>Street Address:</td> <td>5775 Morehouse Drive</td> </tr> <tr> <td>City:</td> <td>San Diego</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>92121</td> </tr> </table>		Name:	Qualcomm Incorporated	Street Address:	5775 Morehouse Drive	City:	San Diego	State/Country:	CALIFORNIA	Postal Code:	92121
Name:	Qualcomm Incorporated										
Street Address:	5775 Morehouse Drive										
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PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13585305</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13585305						
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Application Number:	13585305										
CORRESPONDENCE DATA											
Fax Number:	8588453983										
Phone:	858-651-6439										
Email:	tamip@qualcomm.com										
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>											
Correspondent Name:	QUALCOMM Incorporated										
Address Line 1:	5775 Morehouse Drive										
Address Line 4:	San Diego, CALIFORNIA 92121										
ATTORNEY DOCKET NUMBER:	121922										
NAME OF SUBMITTER:	Tami M. Procopio										
Total Attachments: 7 source=121922assign#page1.tif											

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source=121922assign#page7.tif

ASSIGNMENT

WHEREAS, WE,

1. **Vineet MITTAL**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA and a resident of San Diego, CA;
2. **Kalle Ilmari AHMAVAARA**, a citizen of Finland, having a mailing address located at 5775 Morehouse Drive, San Diego, CA and a resident of San Diego, CA; and
3. **Prabhu GOVINDASWAMY**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA and a resident of San Diego, CA;

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **METHODS, SYSTEMS AND DEVICES FOR DYNAMIC HPLMN CONFIGURATION** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). _____ filed _____, Qualcomm Reference No. **121922**, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the

world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 9th Aug 2012
LOCATION DATE
Vincent MITTAL

Done at _____, on _____
LOCATION DATE
Kalle Ilmari AHMAVAARA

Done at _____, on _____
LOCATION DATE
Prabhu GOVINDASWAMY

ASSIGNMENT

WHEREAS, WE,

Vineet MITTAL, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA and a resident of San Diego, CA;

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WHEREAS, QUALCOMM Incorporated (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____

LOCATION

DATE

Vineet MITTAL

Done at Son Page, on Aug 9th 2012

1116 Mittal

LOCATION

DATE

Kalle Ilmari

AHMAVAARA

Done at _____, on _____

LOCATION

DATE

Prabhu

GOVINDASWAMY

PATENT

QUALCOMM Ref. No. 121922

Page PAGE1 of NUMPAGES 2

ASSIGNMENT

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Done at _____, on _____
LOCATION DATE Vineet MITTAL

Done at _____, on _____
LOCATION DATE Kalle Ilmari AHMAVAARA

Done at San Diego, CA, on 8/9/2012
LOCATION DATE 
Prabhu GOVINDASWAMY